## 0.5 - 18.0 GHz High Power SPDT Switch



The TGS2353-2 performance allows it to be used in a variety of applications across commercial and military markets, low and high power.

## Block Diagram



## Applications

- Commercial and Military Radar
- Communications
- Electronic Warfare
- Test Instruments
- General Purpose


## Ordering Information

| Part No. | Description |
| :--- | :--- |
| TGS2353-2 | $0.5-18$ GHz High Power Switch |
| TGS2353-2 EVB | Evaluation Board |

Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied.

## Absolute Maximum Ratings

| Parameter | Value |
| :--- | :---: |
| Control Voltage (Vc) | -50 V |
| Control Current (Ic) | -1.5 to 6.0 mA |
| Power Dissipation, (Polss), CW | 3.5 W |
| RF Input Power, CW, $50 \Omega, \mathrm{~T}=25^{\circ} \mathrm{C}$ | 41 dBm |
| Mounting Temperature $(30 \mathrm{sec})$ | $320^{\circ} \mathrm{C}$ |
| Storage Temperature | -55 to $150^{\circ} \mathrm{C}$ |

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Recommended Operating Conditions

| Parameter | Min |  |  | Typ. Max |  | Units |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Frequency | 0.5 |  | 18 | GHz |  |  |
| Input Power Handling <br> (CW) |  | 41 |  | dBm |  |  |
| Control Voltage |  | -40 |  | V |  |  |
| Temperature Range | -40 | 25 | +85 | ${ }^{\circ} \mathrm{C}$ |  |  |

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

## Electrical Specifications

Test conditions unless otherwise noted: $\mathrm{T}_{\mathrm{BASE}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{C} 1}=-40 / 0 \mathrm{~V}, \mathrm{~V} \mathrm{C} 2=0 /-40 \mathrm{~V}$, CW Input Power, see Function Table on page 4

| Parameter | Conditions | Min | Typical |  | Max |
| :--- | :--- | :---: | :---: | :---: | :---: |
| Operational Frequency Range |  | 0.5 |  | 18 | Units |
| Insertion Loss | On-State |  | $<1.5$ |  | dB |
| Input Return Loss - Common Port RL | On-State |  | 15 |  | dB |
| Output Return Loss - Switched Port RL | On-State |  | 15 |  | dB |
| Isolation | Off-State |  | 30 |  | dB |
| Output Return Loss - Isolated Port RL | Off-State |  | 2.5 |  | dB |
| Input Power |  |  | 40 |  | dBm |
| Switching Speed | ON |  | 31 |  | nS |
| Switching Speed | OFF |  | 18 | nS |  |
| Insertion Loss Temperature Coefficient |  |  | 0.003 |  | $\mathrm{~dB} /{ }^{\circ} \mathrm{C}$ |

## Thermal and Reliability Information

| Parameter | Test Conditions | Value | Units |
| :---: | :---: | :---: | :---: |
| Thermal Resistance ( $\left.\theta_{\mathrm{Jc}}\right)^{(1,2)}$ | $\mathrm{T}_{\text {BASE }}=85^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{C} 1}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{C} 2}=-40 \mathrm{~V}$, freq. $=14 \mathrm{GHz}$ | 19.78 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Channel Temperature ( $\mathrm{T}_{\text {cH }}{ }^{(1,2)}$ | Pin $=10 \mathrm{~W}, \mathrm{Pdiss}=3.7 \mathrm{~W}$ | 158 | ${ }^{\circ} \mathrm{C}$ |

1. MMIC soldered to 40 mil thick Cu-Mo carrier plate using AuSn solder. Thermal resistance is determined from the channel to the back of the carrier plate (fixed $85^{\circ} \mathrm{C}$ temp.).
2. Refer to the following document: GaN Device Channel Temperature, Thermal Resistance, and Reliability Estimates

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## Performance Plots - Small Signal




Return Loss (On-State) vs. Frequency


Return Loss (Off-State) vs. Frequency



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## Applications Circuit



Notes:
$V_{C 1}$ can be biased from either bond pad 3 or 6 , and the non-biased bond pad can be left open. $V_{C 2}$ can be biased from either bond pad 2 or 7 , and the non-biased bond pad can be left open.

This switch can be configured as a Single Pole, Single Throw (SPST) by terminating one unused RF switched port with a 50 Ohm load.

## Bias Up Procedure

1. $\mathrm{V}_{\mathrm{C} 1}$ or $\mathrm{V}_{\mathrm{C} 2}$ set to 0 V (see Function Table for RF Path)
2. $\mathrm{V}_{\mathrm{C} 2}$ or $\mathrm{V}_{\mathrm{C} 1}$ set to -40 V (see Function Table for RF Path)
3. Apply RF signal to RF Input

## Bias Up Down

1. Turn off RF supply
2. Turn $\mathrm{V}_{\mathrm{C} 2}$ or $\mathrm{V}_{\mathrm{C} 1}$ to 0 V
3. Turn $\mathrm{V}_{\mathrm{C} 1}$ or $\mathrm{V}_{\mathrm{C} 2}$ to 0 V

## Function Table

| RF Path |  | $\mathbf{V}_{\mathbf{C 1}}$ | $\mathbf{V}_{\mathbf{C 2}}$ |
| :--- | :--- | :---: | :---: |
| RF In to RF Out1 (50 $\Omega$ load to RF Out2) | On-State (Insertion Loss) | 0 V | -40 V |
|  | Off-State (Isolation) | -40 V | 0 V |
| RF In to RF Out2 (50 $\Omega$ load to RF Out1) | On-State (Insertion Loss) | -40 V | 0 V |
|  | Off-State (Isolation) | 0 V | -40 V |

## 0.5 - 18.0 GHz High Power SPDT Switch

## Evaluation Board (EVB) Layout Assembly \& Mounting Detail



MOUNTING DETAIL

RF Layer is $0.010^{\prime \prime}$ thick Rogers Corp. RO4350B, $\varepsilon r=3.48$. Metal layers are 0.5 oz . copper. The microstrip line at the connector interface is optimized for the Southwest Microwave end launch connector 1092-02A-5.

The pad pattern shown has been developed and tested for optimized assembly at Qorvo Semiconductor. The PCB land pattern has been developed to accommodate lead and package tolerances. Since surface mount processes vary from company to company, careful process development is recommended.

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## Mechanical Drawing and Bond Pad Description



Unit: millimeters
Thickness: 0.10
Die x, y size tolerance: +/- 0.050
Chip edge to bond pad dimensions is shown to center of pad Ground is backside of die

| Pin No. | Symbol | Description | Pad Size (mm) |
| :---: | :---: | :---: | :---: |
| 1 | RF In | Input, RF common port; matched to $50 \Omega$; DC coupled | $0.100 \times 0.200$ |
| 2, 7 | $\mathrm{V}_{\mathrm{C} 2}$ | Control voltage 2; can be biased from either side. | $0.100 \times 0.100$ |
| 3, 6 | $\mathrm{V}_{\mathrm{C} 1}$ | Control voltage 1; can be biased from either side. | $0.100 \times 0.100$ |
| 4 | RF Out1 | Output 1, RF switched port 1; matched to $50 \Omega$; DC coupled | $0.200 \times 0.100$ |
| 5 | RF Out2 | Output 2, RF switched port 2; matched to $50 \Omega$ DC coupled | $0.200 \times 0.100$ |

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## Assembly Notes

Component placement and adhesive attachment assembly notes:

- Vacuum pencils and/or vacuum collets are the preferred method of pick up.
- Air bridges must be avoided during placement.
- The force impact is critical during auto placement.
- Organic attachment (i.e., conductive epoxy) can be used in low-power applications.
- Curing should be done in a convection oven; proper exhaust is a safety concern.

Reflow process assembly notes:

- Use $\operatorname{AuSn}(80 / 20)$ solder and limit exposure to temperatures above $300^{\circ} \mathrm{C}$ to $3-4$ minutes, maximum.
- An alloy station or conveyor furnace with reducing atmosphere should be used.
- Do not use any kind of flux.
- Coefficient of thermal expansion matching is critical for long-term reliability.
- Devices must be stored in a dry nitrogen atmosphere.

Interconnect process assembly notes:

- Thermosonic ball bonding is the preferred interconnect technique.
- Force, time, and ultrasonic are critical parameters.
- Aluminum wire should not be used.
- Devices with small pad sizes should be bonded with 0.0007 -inch wire.


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## Handling Precautions

|  | Rating | Standard |  |
| :--- | :---: | :--- | :--- |
| ESD-Human Body Model (HBM) | 1 A | ESDA/JEDEC JS-001 | Caution! |

## Solderability

Use only AuSn (80/20) solder and limit exposure to temperatures above $300^{\circ} \mathrm{C}$ to $3-4$ minutes, maximum.

## RoHS Compliance

This product is compliant with the 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment), as amended by Directive 2015/863/EU. This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A $\left(\mathrm{C}_{15} \mathrm{H}_{12} \mathrm{Br} \mathrm{H}_{4} \mathrm{O}_{2}\right)$ Free
- PFOS Free
- SVHC Free


## Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:
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Web: www.gorvo.com

## Email: customer.support@qorvo.com

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